

# VIAVI TestCenter Data Center Bundle

## For AION

### Application Overview

**VIAVI TestCenter Data Center Bundle for AION** supports high performance and realistic topologies for Layer 2 and Layer 3 overlay networks, data center interconnect, multi-path high-availability, and switching and storage technologies used in Data Centers.

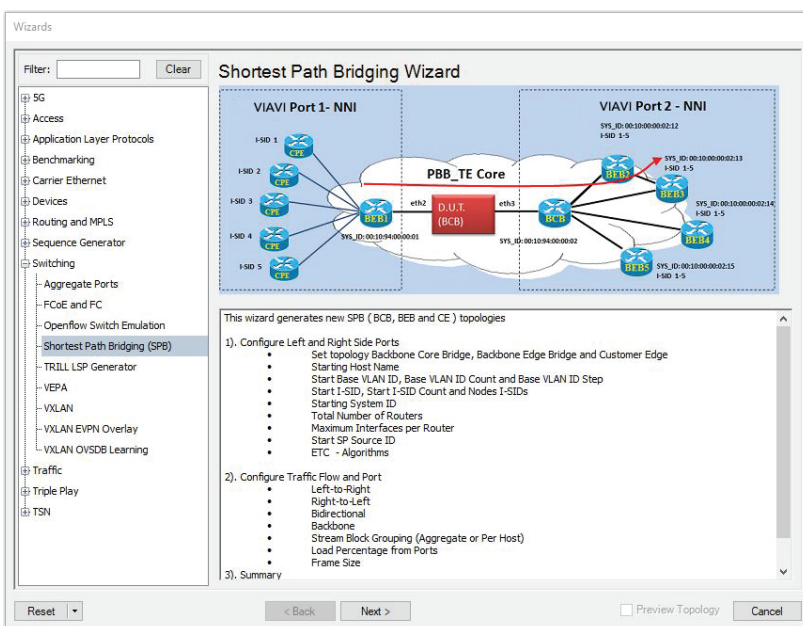
It enables Network Equipment Manufacturers, Service Providers and Enterprises to quickly evaluate and troubleshoot functionality, performance, and scalability of any data center fabric.

These solutions allow users to expose the true performance of high-speed, high-density switches and routers and overall system architecture for datacenter network with ever increasing port densities and speeds under various traffic conditions.

The **Data Center Bundle** features offer comprehensive testing of Layer 2 overlay multipath networks and storage fabrics.

### Key Use Cases and Benefits

- **Layer 2 Overlay Network Performance** – Verify reliability, scale, and performance of Layer 2 overlay networks with multipath and redundancy capabilities in large scale data center deployments using SPB, TRILL and OTV
- **Testing Converged Fabrics** – End to end FCoE to FC performance emulating virtual machine initiators on Ethernet and storage array targets on native Fiber Channel test ports
- **Increase Productivity** – Test and configuration wizards allow quick setup; capture functionality, protocol events and live status views make troubleshooting easy with TestCenter IQ and help save time
- **Cost-Effective Solution** – Commonly used in data center - L2 overlay and storage protocol emulations in a single affordable package
- **Trusted Partner** – Benefit from decades of testing experience with VIAVI as your guide through a world of complex testing



Shortest Path Bridging Configuration Wizard

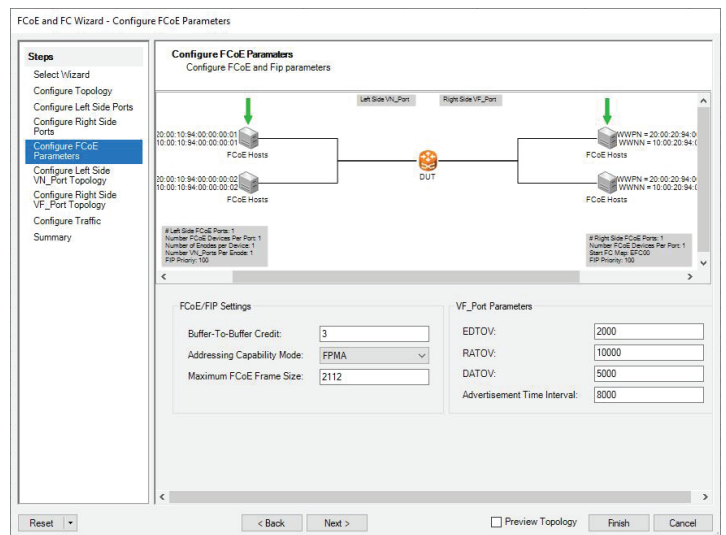
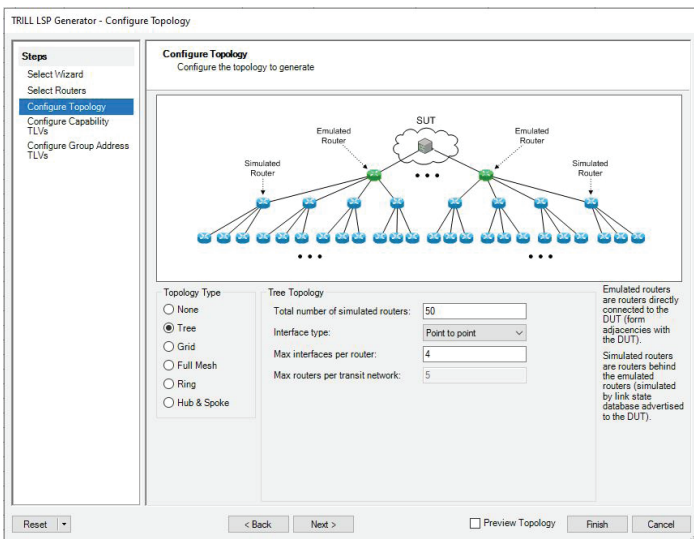
**Layer 2 (L2) Overlay Protocols** such as Shortest Path Bridging (SPB), Transparent Interconnect for Lots of Links (TRILL), Overlay Transport Virtualization (OTV), Provider Link State Bridging (PLSB), Virtual Ethernet Port Aggregator (VEPA) included in this package, help quickly evaluate and troubleshoot different types of L2 fabric, forwarding behavior, and performance in devices and data center networks.

**SPB emulation** facilitates multiple SPB adjacencies, hundreds of SPB nodes, and thousands of emulated ISIDs and MAC addresses, SPB traffic with 802.1ah MAC in MAC encapsulation, to test the throughput scale of data center switches and fabrics. It can further be used to test 802.1aq SPB in combination with 802.1ag Connectivity Fault Management capabilities.

**TRILL emulation** validates the implementation of TRILL Routing Bridge (RBridge) regarding Ingress/Egress or Transit functions, IS-IS exchange information, multicast tree pruning, load balancing, and topology changes. It allows emulation of large networks by generating thousands of TRILL LSPs and complex network maps.

**OTV emulation** delivers a virtual L2 transport over any L3 Infrastructure.

**Fiber Channel over Ethernet (FCoE)** technology provides a method of transporting Fiber Channel traffic over a physical Ethernet connection. The FCoE Initialization Protocol (FIP) allows the switch to discover and initialize FCoE-capable entities that are connected via Ethernet. The Data Center Bridging eXchange (DCBX) protocol is an extension of the Link Layer Discovery Protocol (LLDP). This package helps to test end to end FC and FCoE interoperability scenarios.



In-depth FCoE Configuration Wizards

## Features and Benefits

- Layer 2 data center overlay technologies like SPB, TRILL, OTV help with testing of functionality, interoperability and staggered network upgrades
- Verify SPB Adjacency, Node, Link and Service scale in CPU (control plane) and ASIC (data plane) components of switches and fabrics
- Test availability of multiple TRILL paths simultaneously for load balancing, multi-homed traffic, and failover scenarios
- Storage testing with Fiber Channel over Ethernet emulation support with dynamic network discovery using LLDP/DCBX
- Validate FCoE single hop vs. multi hop fabric redundancy and performance impact of possible head of line blocking (HLOB) with nanoseconds accurate data plane latency
- Verify no flooding, MAC learning and broadcasts over Shortest Path Bridging 802.1ah MAC in MAC data plane and FCoE data plane, VLANs and MAC address spoofing prevention capabilities of the fabric, VSANs and FIP snooping with dynamic Access Control Lists (ACLs)
- Report SPB Multi-path and Multi-priority Queueput per latest IETF draft specification with FCoE, unicast and multicast LAN traffic utilizing the VIAVI TestCenter data center bridging benchmarking test package
- Validate scalability and protocol functionality in the same test by running multiple protocols concurrently on each port
- Using advanced multi-threading architecture, user can scale number of sessions or route scale with multi-dimension
- Use the Command Sequencer with TCL scripts to send SNMP commands, get SNMP data, configure the device under test, run entire test and generate pass/fail results; advanced command sequencer capabilities allow users to extend VIAVI TestCenter to meet their test needs

## Technical Specifications

Parameter	Description
<i>Storage Fabrics</i>	
FCoE	<ul style="list-style-type: none"> <li>• FIP–FCoE Initialization Protocol emulation (FLOGI/FLOGO)</li> <li>• Server VN_Port and Fabric FCF VF_Port emulation</li> <li>• Automatic VLAN discovery</li> <li>• Multiple ENode and VN_Port emulation to FCF switch</li> <li>• NPIV VN_Port emulation to FCF, NPV and FIP snooping bridge switches</li> </ul>
LLDP/DCBX	<ul style="list-style-type: none"> <li>• Link Layer Discovery Protocol (LLDP) emulation</li> <li>• Auto-negotiation of 802.1Qbb Priority Flow Control (PFC) and 802.1Qaz Enhanced</li> <li>• Transmission Selection (ETS)</li> </ul>
<i>Layer 2 Overlay</i>	
TRILL	<ul style="list-style-type: none"> <li>• RBridge (Routing Bridge) emulation</li> <li>• Multi-VLAN support</li> <li>• Designated RBridge election</li> <li>• RBridge nickname collision resolution</li> <li>• Appointed Forwarder designation</li> </ul>
SPB	<ul style="list-style-type: none"> <li>• 802.1aq Shortest Path Bridging MAC (SPBM) BEB or BCB emulation</li> <li>• 802.1ah traffic via Mac-in-Mac encapsulation</li> <li>• ISIS emulation of Level 1, Level 2, Level 1/2 routers</li> <li>• SPBM ISID UNI and NNI Node and Link</li> </ul>
OTV	Overlay Transport Virtualization
VEPA	Virtual Ethernet Port Aggregator (IEEE 802.1QBG)
PLSB	Provider Link State Bridging

## Ordering Information

Product Number	Description
AON-PB-DC*	AION Data Center Bundle

\*Requires AION Routing and Switching (AON-PB-RTSW) license.

Bundles are available in different number of seats, contact your VIAVI Sales Representative to find the right combination for your testing needs.

## About AION

**VIAVI AION** is a flexible delivery platform that enables users to achieve improved deployment and provisioning for all their cloud and network testing needs. Built with your needs in mind, offering maximum flexibility in acquiring and utilizing VIAVI TestCenter platforms.

The extended platform combines a wealth of industry-leading test solutions with a flexible licensing architecture to support a wide range of next-generation solution-based domain applications.

AION offers a centralized management hub to help leverage software and hardware functionalities across all lab users and locations for a simplified management and decision-making process:

- **Flexible purchasing options** available via subscription, consumption-based, and perpetual plans, with the ability to license different bandwidth, scale, and protocol bundles.
- **Flexible deployment options** offered include cloud-delivery, on-prem, and laptop-hosted licensing services.

Enhanced user serviceability delivers always-on platform services from auto-discovery and inventory management to user and workspace administration, notifications, and log aggregation.



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